

Product Specification

XBLW AO3407

P-Channel Enhancement Mode MOSFET











Description

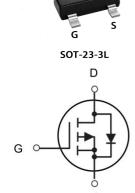
The AO3407 uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

- > VDS = -30V,ID = -4.1A
- \triangleright RDS(ON) <55m Ω @ VGS=10V

Application

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- > PWM applications
- Load switch
- Power management



P-Channel MOSFET

Package Marking and Ordering Information

Product Model	Package Type	Marking	Packing	Packing Qty
XBLW AO3407	SOT-23-3L	X7XH	Tape	3000Pcs/Reel

Absolute Maximum Ratings (TA=25°Cunless otherwise noted)

Symbol	Parameter	Limit	Unit	
V _{DS}	Drain-Source Voltage	-30	V	
V _{GS}	Gate-Source Voltage	±20	V	
ID	Drain Current-Continuous	-4.1	А	
Ірм	Drain Current-Pulsed (Note 1)	-13	А	
P _D	Maximum Power Dissipation	1.32	W	
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\mathbb{C}$	
Reja	Thermal Resistance,Junction-to-Ambient (Note 2)	125	°C/W	



Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V
$\triangle BV_{DSS}/\triangle T_J$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.02		V/°C
D	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-3A		42	55	mΩ
R _{DS(ON)}		V _{GS} =-4.5V , I _D =-1.5A		90	98	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	V _{GS} =V _{DS} . I _D =-250uA	-1.2	-1.5	-2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID250UA		4.32		mV/°C
less	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1	uA
IDSS		V _{DS} =-24V , V _{GS} =0V , T _J =55°C			-5	uA
Igss	Gate-Source Leakage Current	V_{GS} =±20 V , V_{DS} =0 V			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-3A		4.8		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		24	48	Ω
Q_g	Total Gate Charge (-4.5V)			5.22	7.3	
Q_gs	Gate-Source Charge	V_{DS} =-20V , V_{GS} =-4.5V , I_{D} =-3A		1.25	1.8	nC
Q_{gd}	Gate-Drain Charge			2.3	3.2	
$T_{d(on)}$	Turn-On Delay Time			18.4	37	
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω I_{D} =-1A		11.4	21	no
$T_{d(off)}$	Turn-Off Delay Time			39.4	79	ns
Tf	Fall Time			5.2	10.4	
Ciss	Input Capacitance			463	650	
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		82	115	pF
C _{rss}	Reverse Transfer Capacitance			68	95	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current ^{1,4}	\/-=\/-=0\/	-		-3.2	Α
I _{SM}	Pulsed Source Current ^{2,4}	V _G =V _D =0V , Force Current			-13	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C	1		-1	V

Note

^{1.} The data tested by surface mounted on a 1 inch $^2\,\text{FR-4}$ board with 2OZ copper.

^{2.}The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$

^{3.}The power dissipation is limited by 150°C junction temperature

^{4.} The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

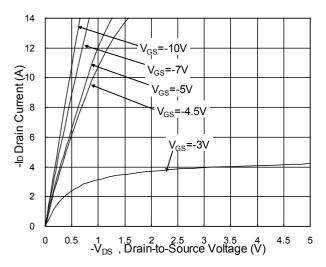


Fig.1 Typical Output Characteristics

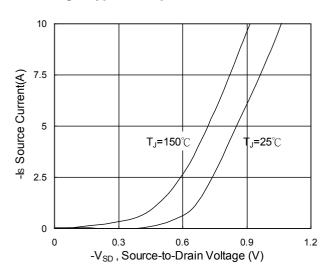


Fig.3 Source Drain Forward Characteristics

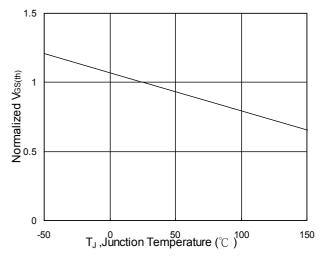


Fig.5 Normalized V_{GS(th)} vs. T_J

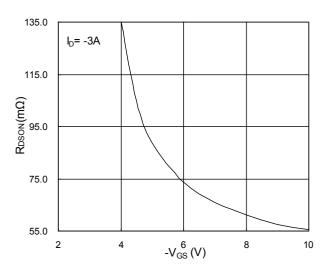


Fig.2 On-Resistance vs. G-S Voltage

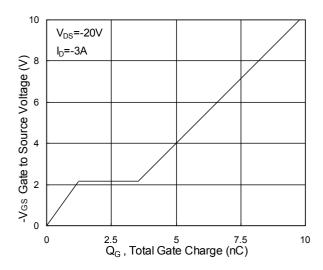


Fig.4 Gate-Charge Characteristics

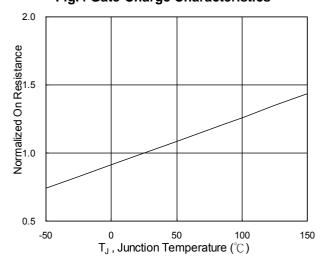
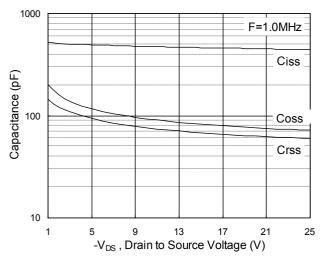


Fig.6 Normalized RDSON vs. TJ





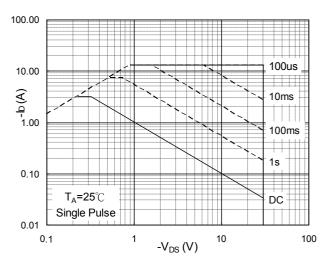


Fig.7 Capacitance

Fig.8 Safe Operating Area

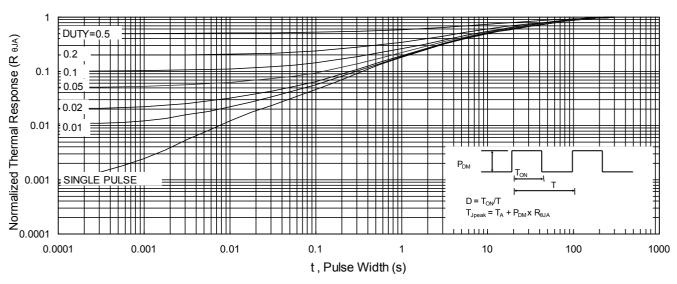
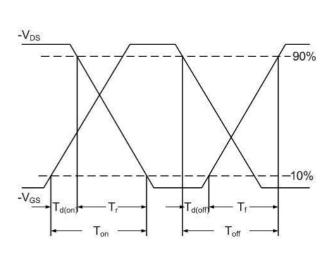


Fig.9 Normalized Maximum Transient Thermal Impedance



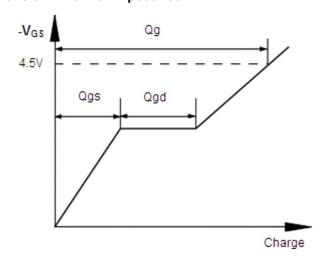


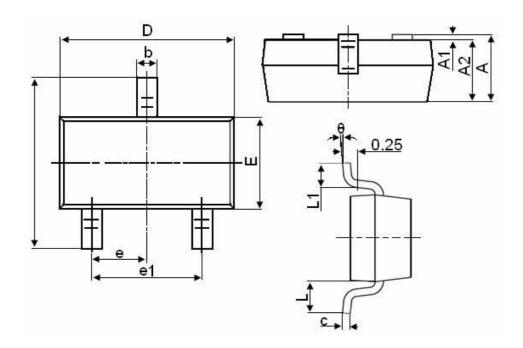
Fig.10 Switching Time Waveform

Fig.11 Gate Charge Waveform



Package Information

SOT-23-3L



	Dimensions in Millimeters		
Symbol	MIN.	MAX.	
А	1.050	1.250	
A1	0.000	0.100	
A2	1.050	1.150	
b	0.300	0.500	
С	0.100	0.200	
D	2.800	3.000	
E	1.500	1.700	
E1	2.650	2.950	
е		0.950TYP	
e1	1.800	2.000	
L		0.550REF	
L1	0.300	0.600	
θ	0°	8°	



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